

# DATA SHEET

## **BLF545** UHF push-pull power MOS transistor

Product specification

October 1992

# UHF push-pull power MOS transistor

# BLF545

## FEATURES

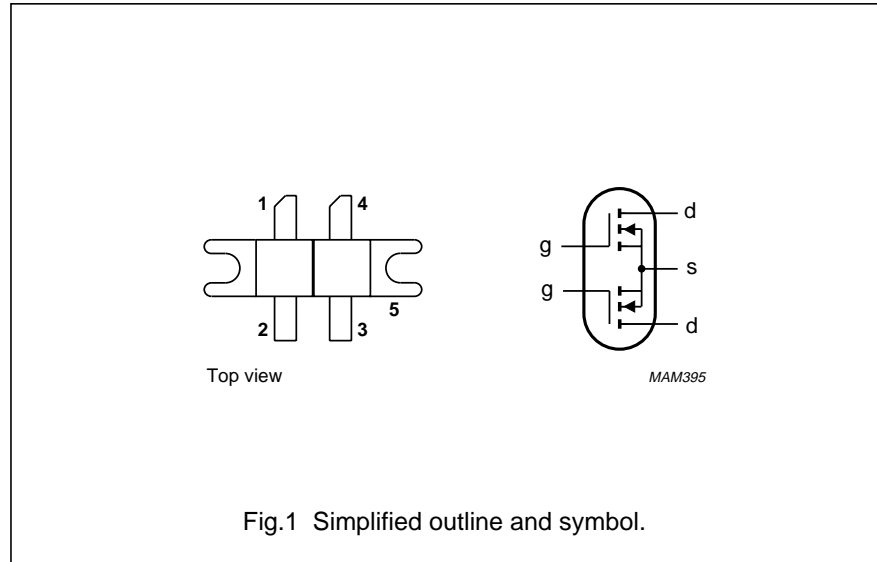
- High power gain
- Easy power control
- Good thermal stability
- Gold metallization ensures excellent reliability
- Designed for broadband operation.

## DESCRIPTION

Silicon N-channel enhancement mode vertical D-MOS push-pull transistor designed for communications transmitter applications in the UHF frequency range.

The transistor is encapsulated in a 4-lead, SOT268 balanced flange envelope, with two ceramic caps. The mounting flange provides the common source connection for the transistors.

## PIN CONFIGURATION



## CAUTION

The device is supplied in an antistatic package. The gate-source input must be protected against static charge during transport and handling.

## PINNING - SOT268

PIN	DESCRIPTION
1	drain 1
2	gate 1
3	gate 2
4	drain 2
5	source

## WARNING

**Product and environmental safety - toxic materials**

This product contains beryllium oxide. The product is entirely safe provided that the BeO discs are not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

## QUICK REFERENCE DATA

RF performance at  $T_h = 25\text{ }^\circ\text{C}$  in a push-pull common source circuit.

MODE OF OPERATION	f (MHz)	$V_{DS}$ (V)	$P_L$ (W)	$G_p$ (dB)	$\eta_D$ (%)
CW, class-B	500	28	40	> 11	> 50

# UHF push-pull power MOS transistor

BLF545

## LIMITING VALUES

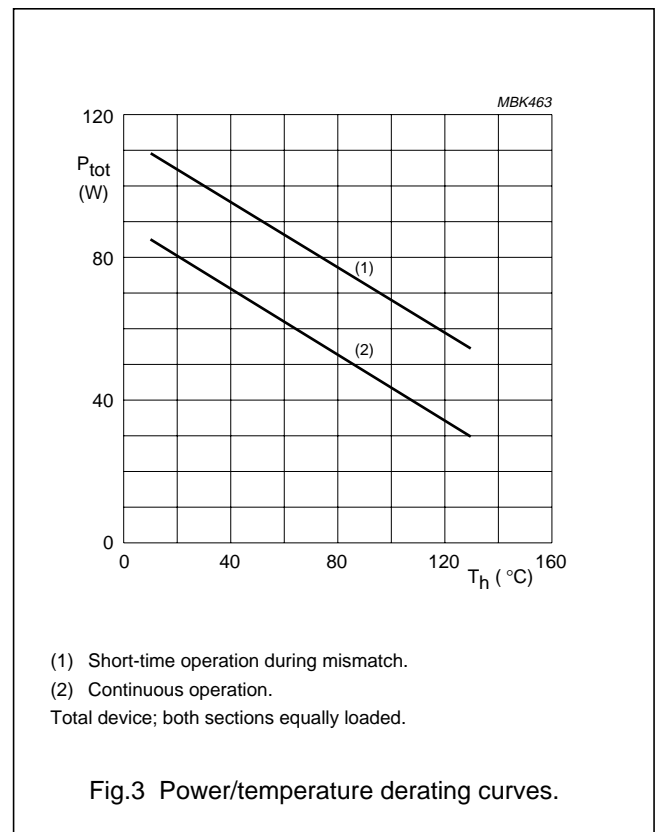
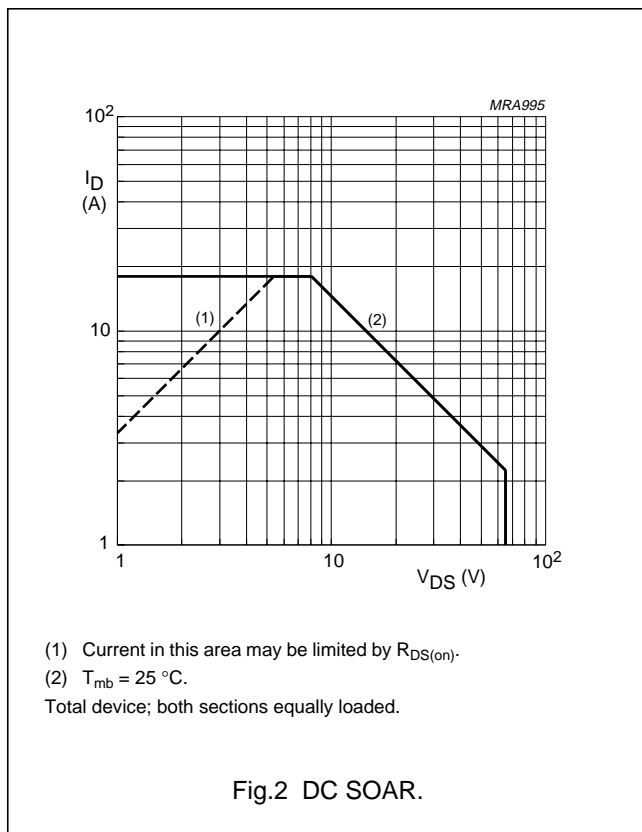
In accordance with the Absolute Maximum System (IEC 134).

Per transistor section unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{DS}$	drain-source voltage		–	65	V
$\pm V_{GS}$	gate-source voltage		–	20	V
$I_D$	DC drain current		–	3.5	A
$P_{tot}$	total power dissipation	up to $T_{mb} = 25\text{ }^\circ\text{C}$ ; total device; both sections equally loaded	–	92	W
$T_{stg}$	storage temperature		–65	150	$^\circ\text{C}$
$T_j$	junction temperature		–	200	$^\circ\text{C}$

## THERMAL RESISTANCE

SYMBOL	PARAMETER	CONDITIONS	THERMAL RESISTANCE
$R_{th\ j-mb}$	thermal resistance from junction to mounting base	total device; both sections equally loaded	1.9 K/W
$R_{th\ mb-h}$	thermal resistance from mounting base to heatsink	total device; both sections equally loaded	0.25 K/W



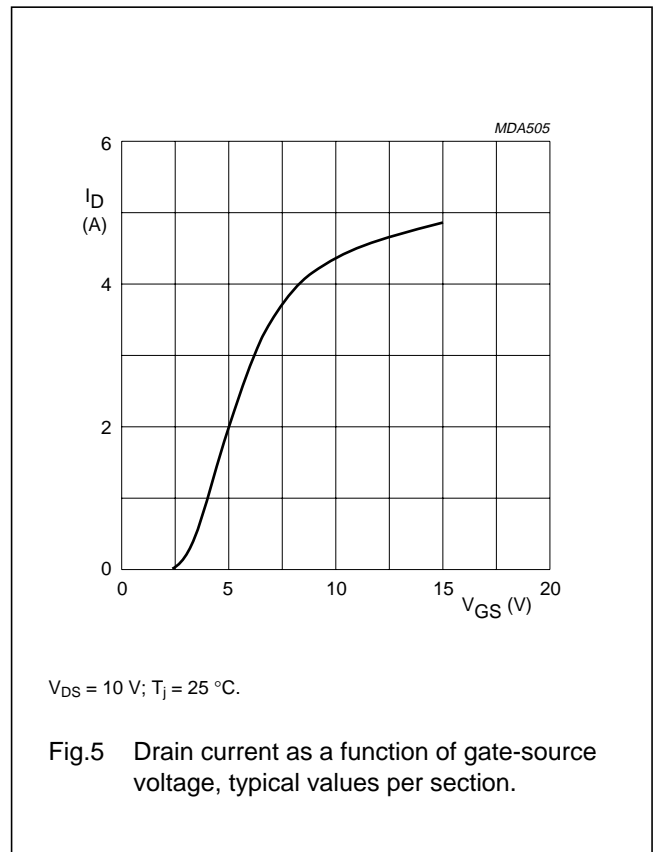
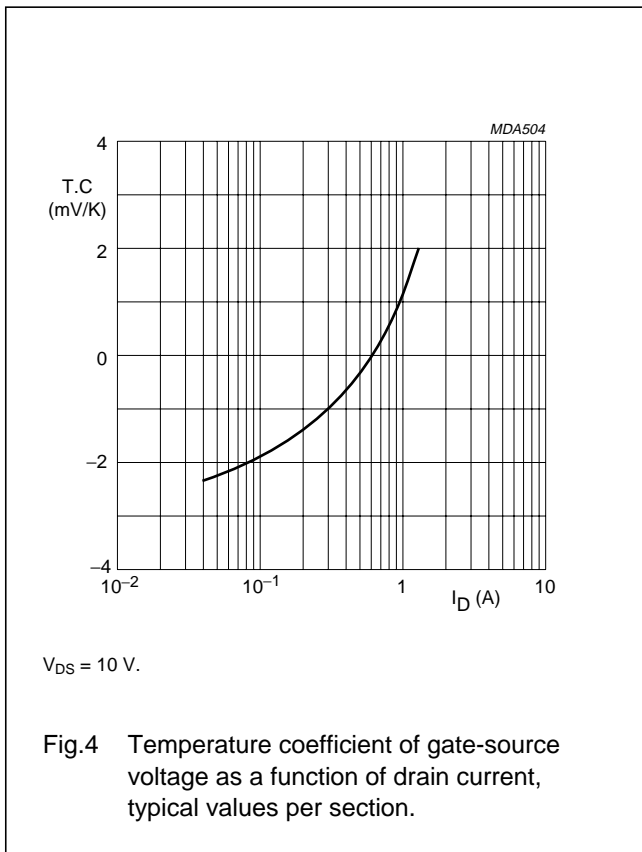
UHF push-pull power MOS transistor

BLF545

**CHARACTERISTICS (per section)**

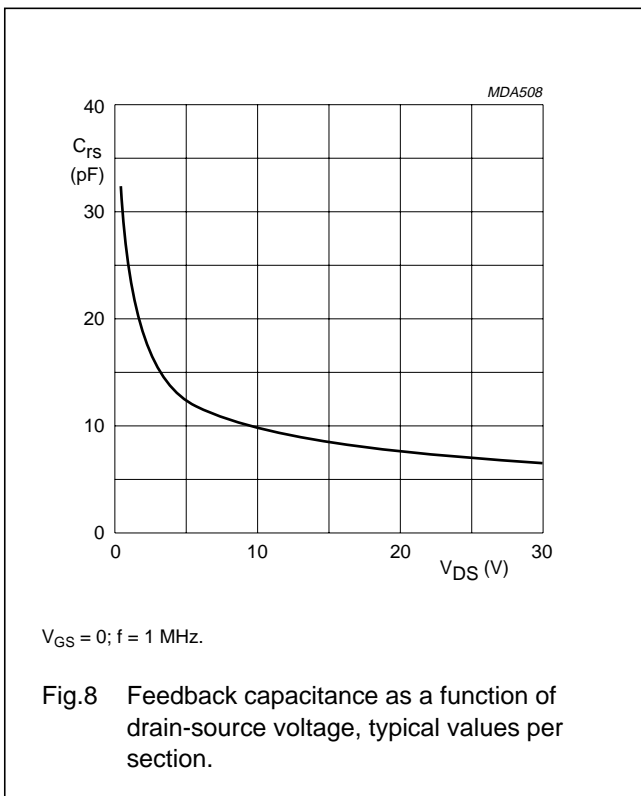
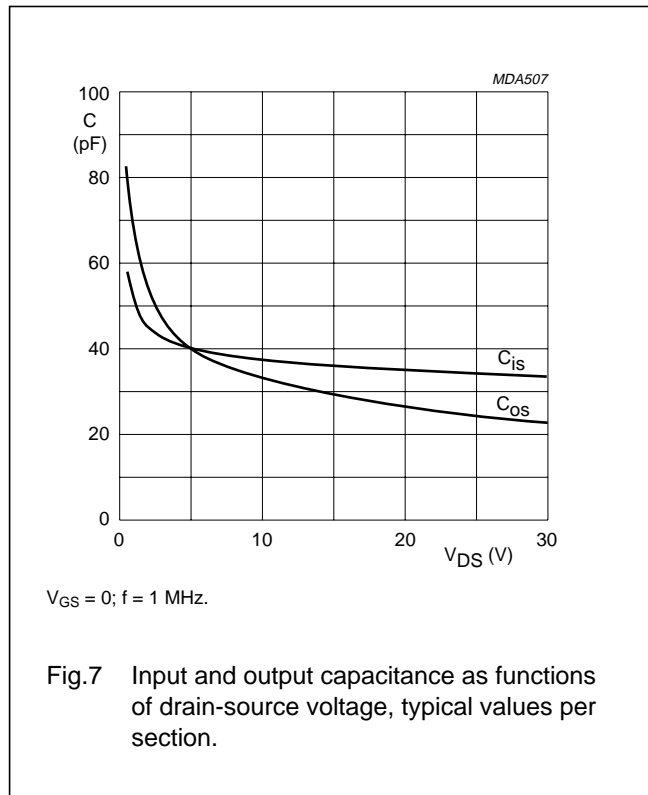
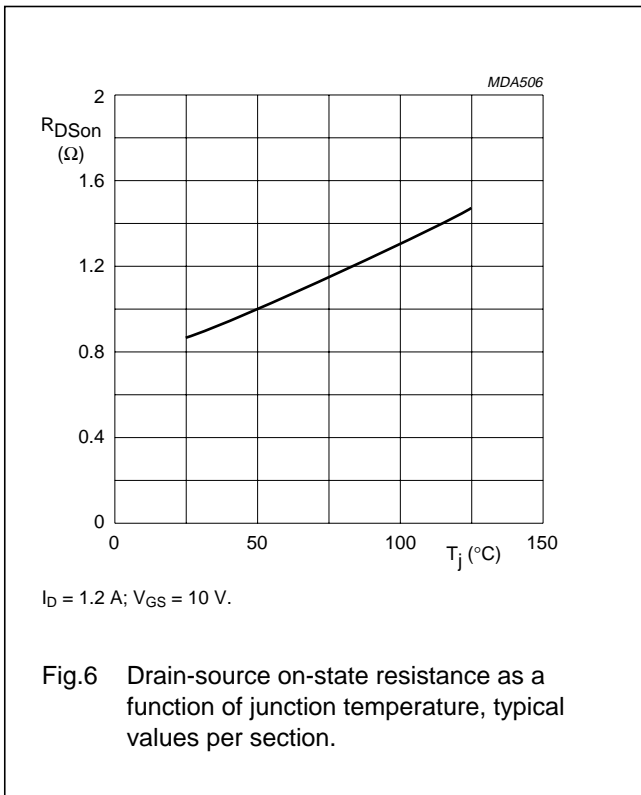
$T_j = 25\text{ }^\circ\text{C}$  unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0; I_D = 10\text{ mA}$	65	–	–	V
$I_{DSS}$	drain-source leakage current	$V_{GS} = 0; V_{DS} = 28\text{ V}$	–	–	1	mA
$I_{GSS}$	gate-source leakage current	$\pm V_{GS} = 20\text{ V}; V_{DS} = 0$	–	–	1	$\mu\text{A}$
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 40\text{ mA}; V_{DS} = 10\text{ V}$	1	–	4	V
$g_{fs}$	forward transconductance	$I_D = 1.2\text{ A}; V_{DS} = 10\text{ V}$	600	900	–	mS
$R_{DS(on)}$	drain-source on-state resistance	$I_D = 1.2\text{ A}; V_{GS} = 10\text{ V}$	–	0.85	1.25	$\Omega$
$I_{DSX}$	on-state drain current	$V_{GS} = 15\text{ V}; V_{DS} = 10\text{ V}$	–	4.8	–	A
$C_{is}$	input capacitance	$V_{GS} = 0; V_{DS} = 28\text{ V}; f = 1\text{ MHz}$	–	32	–	pF
$C_{os}$	output capacitance	$V_{GS} = 0; V_{DS} = 28\text{ V}; f = 1\text{ MHz}$	–	24	–	pF
$C_{rs}$	feedback capacitance	$V_{GS} = 0; V_{DS} = 28\text{ V}; f = 1\text{ MHz}$	–	6.4	–	pF



UHF push-pull power MOS transistor

BLF545



# UHF push-pull power MOS transistor

BLF545

## APPLICATION INFORMATION FOR CLASS-B OPERATION

$T_h = 25\text{ }^\circ\text{C}$ ;  $R_{th\ mb-h} = 0.25\text{ K/W}$ , unless otherwise specified.

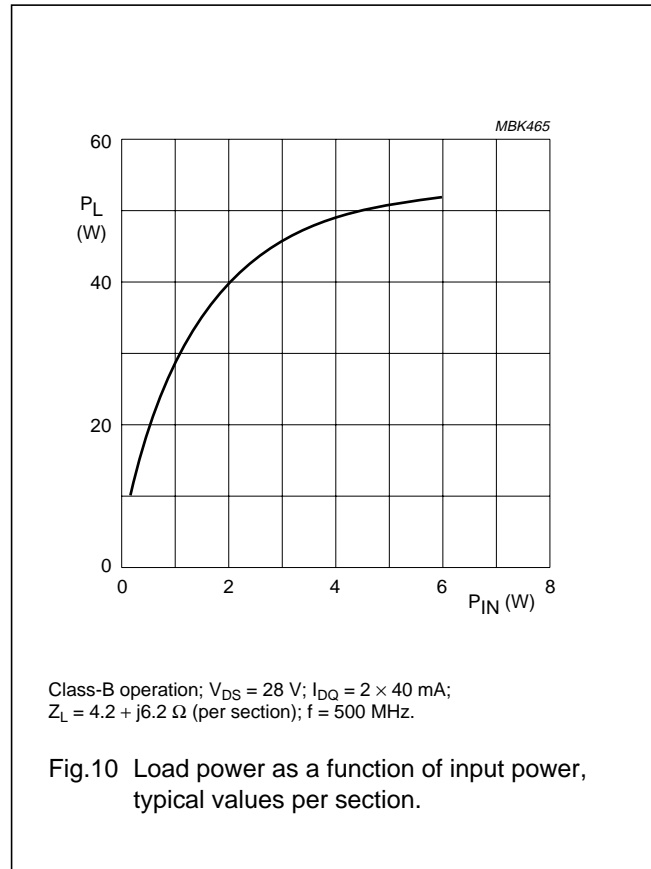
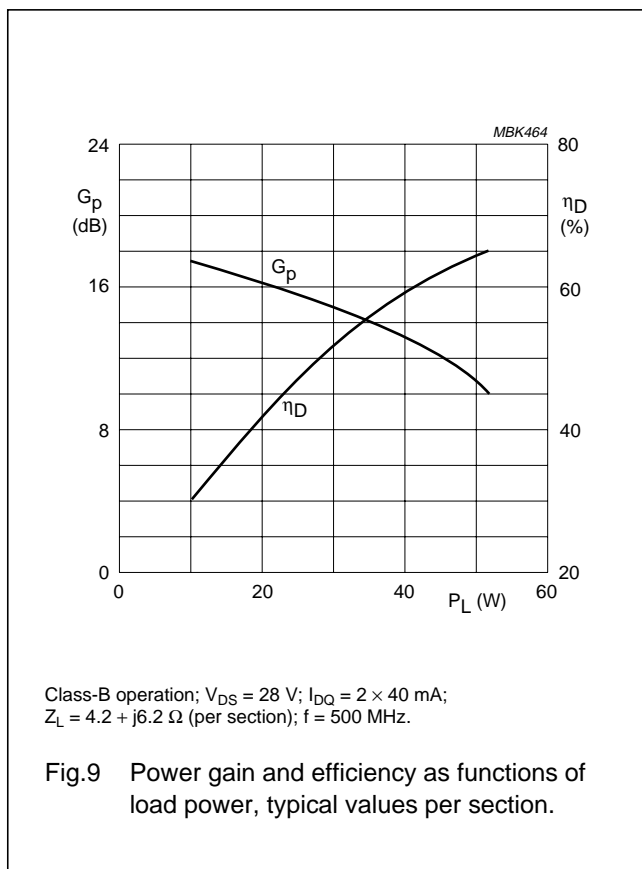
RF performance in a common source, class-B, push-pull circuit.

MODE OF OPERATION	f (MHz)	V <sub>DS</sub> (V)	I <sub>DQ</sub> (mA)	P <sub>L</sub> (W)	G <sub>p</sub> (dB)	η <sub>D</sub> (%)
CW, class-B	500	28	2 × 40	40	> 11 typ. 13	> 50 typ. 60

### Ruggedness in class-B operation

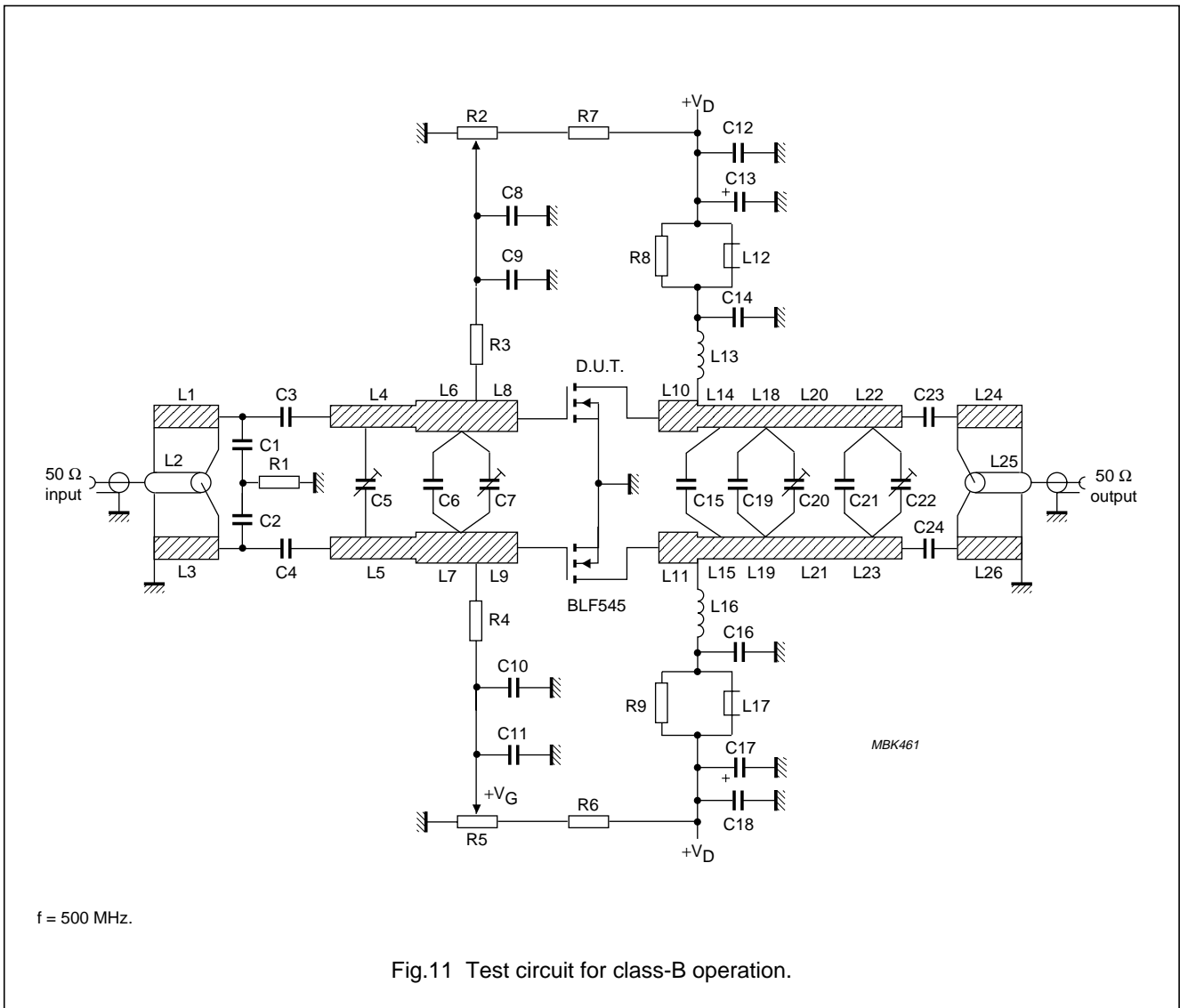
The BLF545 is capable of withstanding a full load mismatch corresponding to VSWR = 50 through all phases under the following conditions:

V<sub>DS</sub> = 28 V; f = 500 MHz at rated output power.



UHF push-pull power MOS transistor

BLF545



f = 500 MHz.

Fig.11 Test circuit for class-B operation.

## UHF push-pull power MOS transistor

BLF545

## List of components (class-B test circuit)

COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1, C2	multilayer ceramic chip capacitor (note 1)	5.1 pF		
C3, C4	multilayer ceramic chip capacitor (note 1)	16 pF		
C5, C7, C20, C22	film dielectric trimmer	1.8 to 10 pF		2222 809 05002
C6	multilayer ceramic chip capacitor (note 1)	22 pF		
C8, C11, C12, C18	multilayer ceramic chip capacitor	100 nF		2222 852 47104
C9, C10, C14, C16	multilayer ceramic chip capacitor (note 1)	390 pF		
C13, C17	electrolytic capacitor	10 $\mu$ F, 63 V		
C15	multilayer ceramic chip capacitor (note 1)	18 pF		
C19	multilayer ceramic chip capacitor (note 1)	13 pF		
C21	multilayer ceramic chip capacitor (note 1)	6.2 pF		
C23, C24	multilayer ceramic chip capacitor (note 1)	10 pF		
L1, L3, L24, L26	stripline (note 2)	50 $\Omega$	56 $\times$ 2.4 mm	
L2, L25	semi-rigid cable (note 3)	50 $\Omega$	ext. dia. 2.2 mm ext. conductor length 56 mm	
L4, L5	stripline (note 2)	56 $\Omega$	13.4 $\times$ 2 mm	
L6, L7	stripline (notes 2 and 4)	56 $\Omega$	9.6 $\times$ 2 mm	
L8, L9	stripline (note 2)	42 $\Omega$	9 $\times$ 3 mm	
L10, L11	stripline (note 2)	42 $\Omega$	6 $\times$ 3 mm	
L12, L17	grade 3B Ferroxcube RF choke			4312 020 36642
L13, L16	4 turns enamelled 1.2 mm copper wire	62 nH	length 7.6 mm int. dia. 5 mm leads 2 $\times$ 5 mm	
L14, L15	stripline (note 2)	56 $\Omega$	8 $\times$ 2 mm	
L18, L19	stripline (note 2)	56 $\Omega$	13 $\times$ 2 mm	
L20, L21	stripline (note 2)	56 $\Omega$	18 $\times$ 2 mm	
L22, L23	stripline (note 2)	56 $\Omega$	14 $\times$ 2 mm	
R1	0.4 W metal film resistor	5.11 $\Omega$		2322 151 75118
R2, R5	10 turns cermet potentiometer	50 k $\Omega$		
R3, R4	0.4 W metal film resistor	10 k $\Omega$		2322 151 71003
R6, R7	0.4 W metal film resistor	205 k $\Omega$		2322 151 72054
R8, R9	1 W metal film resistor	10 $\Omega$		2322 151 71009

## Notes

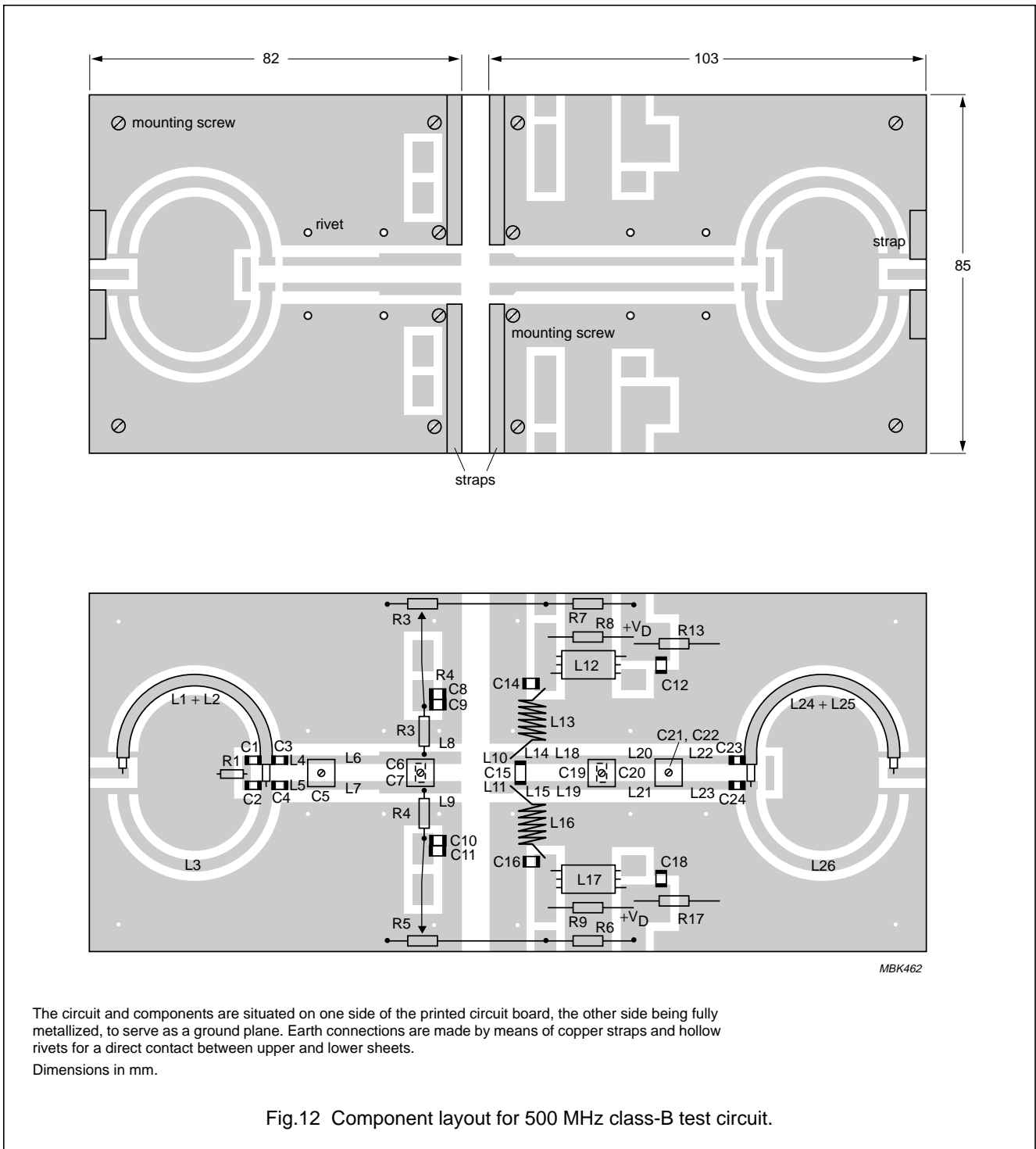
1. American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.



UHF push-pull power MOS transistor

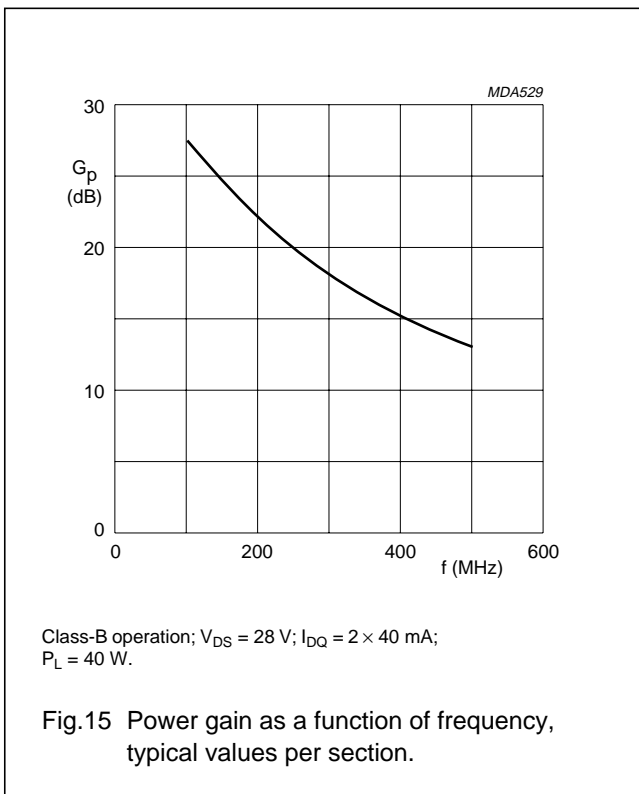
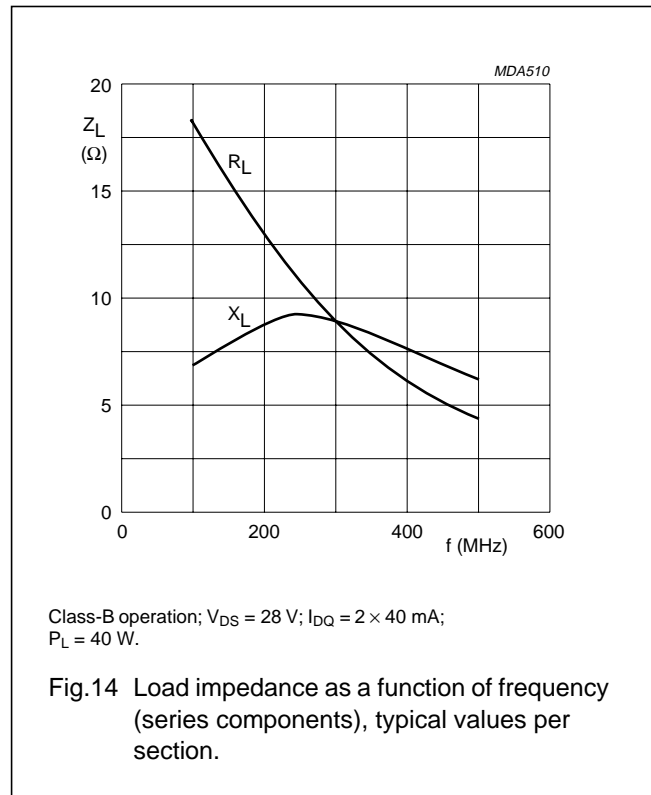
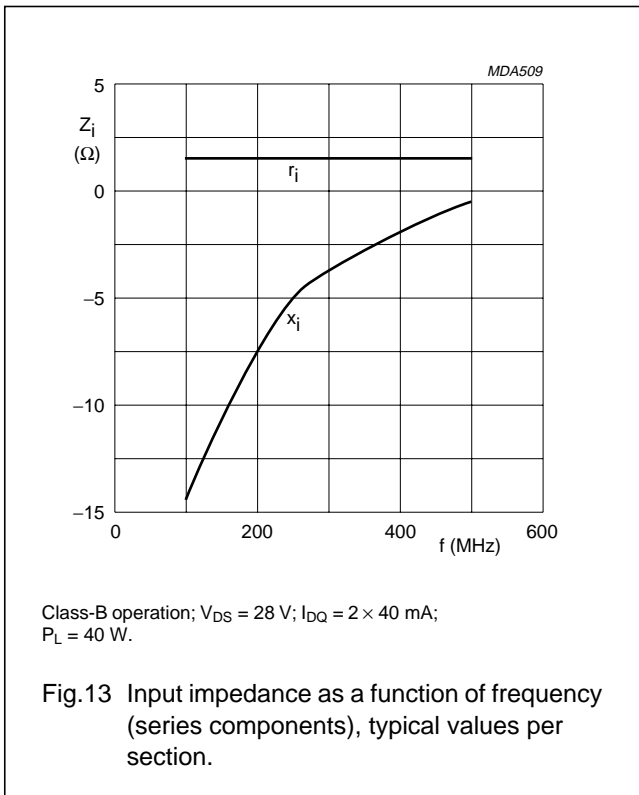
BLF545

2. The striplines are on a double copper-clad printed circuit board, with glass microfibre reinforced PTFE ( $\epsilon_r = 2.2$ ); thickness  $\frac{1}{32}$  inch.
3. Semi-rigid cables L2 and L25 are soldered on to striplines L1 and L26.
4. Striplines L6 and L7 are used in series with a  $42 \Omega$  stripline ( $11 \times 3$  mm).



UHF push-pull power MOS transistor

BLF545



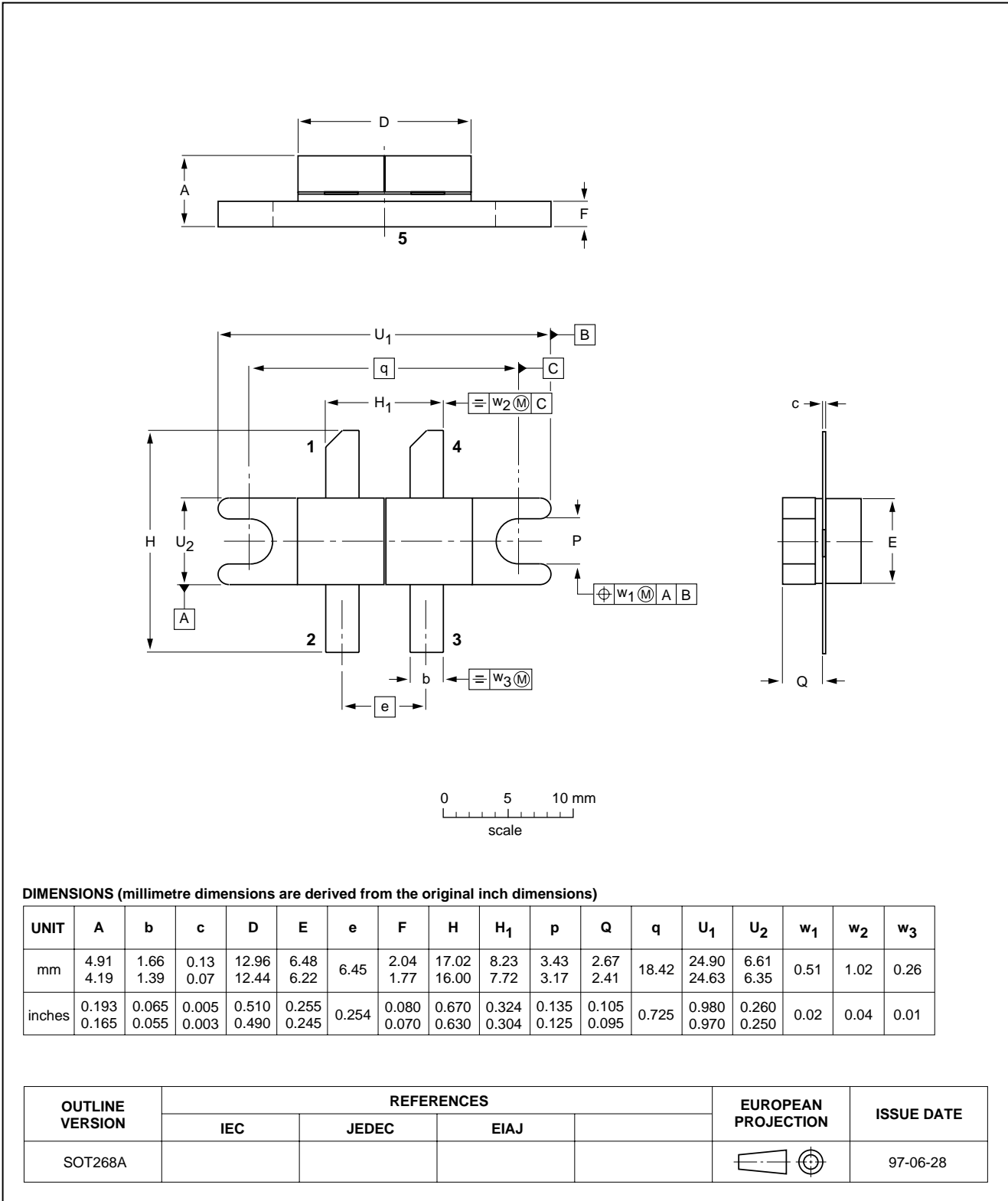
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BLF545

## PACKAGE OUTLINE

Flanged double-ended ceramic package; 2 mounting holes; 4 leads

SOT268A



## UHF push-pull power MOS transistor

BLF545

**DEFINITIONS**

<b>Data Sheet Status</b>	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
<b>Limiting values</b>	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
<b>Application information</b>	
Where application information is given, it is advisory and does not form part of the specification.	

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